HSXA0100-YT HSXF0100-YT HSXC0100-YT

Absolute Pressure Sensor (0-1 BAR)

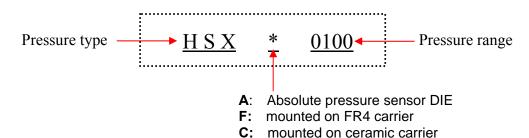


- 0 to 100kPa pressure range (1 bar or 15 PSI)
- Absolute pressure sensor
- high stability
- Miniature surface mount
- RoHS-compatible & Pb-free
- Provide the other gage pressure range sensor

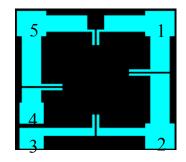
DESCRIPTION

The series sensors are produced under the combination of micro machining technology used in IC and MEMS technology. These absolute sensors can be soldered on PCB directly, which reduces cost without sacrificing steadiness. The sensors also can be packed into other forms which better features and wider measuring range will be achieved. By integrating amplifer, zero and sensitivity compensation circuits, ADC and MCU into the same board, the intelligent sensor modules simplify the design work greatly in the most of applications concerning pressure measurements. HSX series sensors are widely used in Altitude measurement, weather forecast, tire pressure monitoring, industrial automation and so on.

Part number System



WAFER ELECTRICAL CONNECTIONS



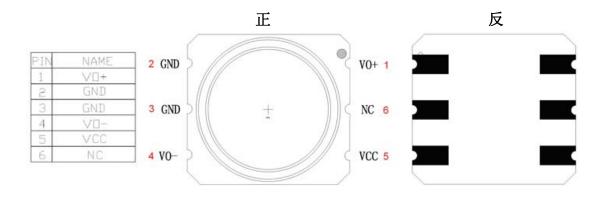
Pad	Connection
1	Vc
2	Vout+
3,4	Vd
5	Vout-

Chip dimensions: $1.6 \times 1.6 \times 0.9$ mm

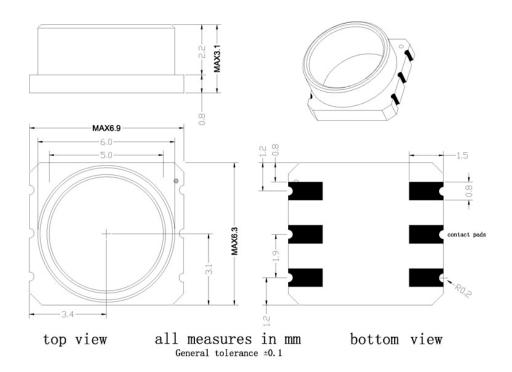
Characteristics

Measurement media	Dry technical gases
Туре	AE2
Output signal	Not Temperatured
Pressure from	Front side
Dimensions	
Chip size (mm ²)	1.6×1.6
Total height (mm)	0.9
Glass thickness (mm)	0.5
Hole diameter (mm)	
Maximum ratings	
Storage temperature T _{st} (C°)	-40150
Operating temperature T _a (C°)	-30135
Supply voltage (max.) V _{DD} (V)	10
Temperature characteristics	
V _{DD} =5V	
Temperature coefficients of the bridge	0.250.35
resistance (%/C°)	
Temperature coefficientsof the	- 0.25 0.15
Sensitivity ($\%/C^{\circ}$)	
Temperature coefficients of the	- 0.10+0.10
Zero (%/C°)	
Characteristics T _a =25C° V _{DD} =5V	
Bridge resistance (min/max)R _s	4.5—5.5
$(K\Omega)$	
Offset voltage (min/max)V ₀	-25+25
(MV)	
Nonlinearity (typ)N _L (%FS)	±0.2
Output span $(typ)V_{SP}$ (MV)	80130

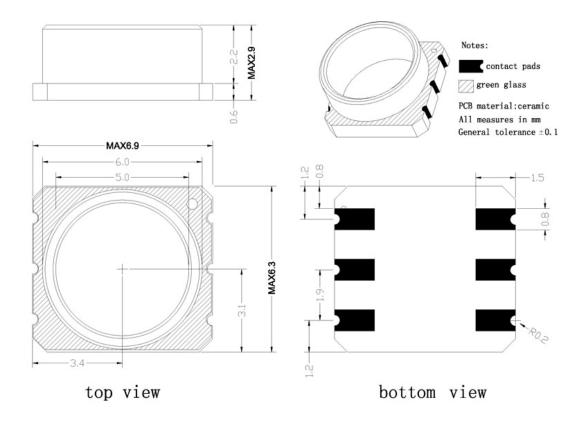
Pin Configuration(SMD)



FR4 Package Outlines



Ceremic Package Outlines



ORDERING INFORMATION

Product Code	Description
HSXA0100	100kpa Absolute Pressure Sensor Die
HSXF0100	100kpa SMD pressure sensor mounted on FR4 Carrier
HSXC0100	100kpa SMD pressure sensor mounted on ceramic Carrier



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